

# RTKA-TCSTKEV1Z

## User's Manual: Evaluation Board

### Industrial Analog and Power

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RTKA-TCSTKEV1Z

Evaluation Board

The “DAQ on a Stick, Renesas Thermocouple” is one of a series of reference designs highlighting Renesas’ precision products. The reference design is a self contained demo showing a complete signal chain solution using Renesas precision parts and a Renesas microcontroller. The complete reference design is conveniently housed in a USB stick form factor. This compact design draws power through the USB port and uses a Graphical User Interface (GUI) to display the real time temperature. [Figure 1](#) shows the Data Acquisition on a Stick reference design.



Figure 1. DAQ on a Stick with Thermocouple

[Figure 2](#) shows a simplified schematic of the thermocouple design. The design uses Renesas’ ISL28134 chopper amplifier, ISL22317 precision Digitally Controlled Potentiometer (DCP), ISL21010 3.3V and 4.096V precision voltage references, the ISL26102 24-bit delta sigma converter, and Renesas R5F10JBC microcontroller.

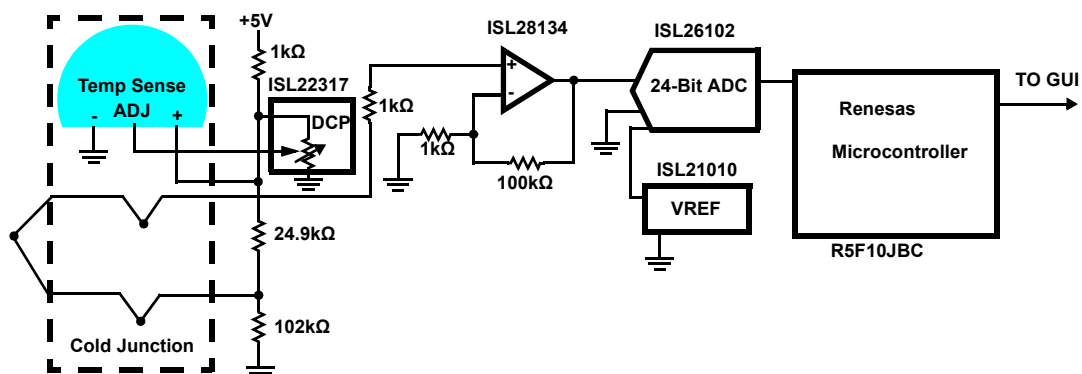


Figure 2. Simplified Thermocouple Schematic

Ordering Information

Part Number	Description
RTKA-TCSTKEV1Z	Evaluation Board

Related Literature

For a full list of related documents, visit our website:

- [ISL28134](#), [ISL21010](#), [ISL26102](#), [ISL22317](#), and [R5F10JBC](#) device pages

## 1. Getting Started

### 1.1 Installing the Graphical User Interface (GUI) Software and USB Drivers

The GUI Software and USB drivers have to be installed on a PC running Windows NT/2000/XP/Vista/Win7/Win 8/Win 10 operating system before connecting the RTKA-TCSTKEV1Z evaluation board to the USB port.

The software and a short video on the operation of this application demonstration can be downloaded or viewed from the Renesas [website](#).

### 1.2 Loading Software

1. Click the **Renesas DAQ on a Stick Software** link to load the executable.
2. Follow the on-screen instructions to complete the software installation. The installation program places the user interface software in the C:\Program Files\R12UZ0047\_DAQ\_V250 directory.
3. To create a shortcut on your desktop, check the **Create a Desktop Icon** box during the software installation.
4. Launch the application by checking the **Launch R12UZ0047\_DAQ\_V250** box, then click **Finish**.

### 1.3 Running the Evaluation Software

1. After software has been installed, connect the RTKA-TCSTKEV1Z board into a USB port on the computer.
2. Click on the Renesas DAQ shortcut (created in [Loading Software](#)) on the desktop. [Figure 3](#) shows the desktop icon. The green LED on the DAQ on a Stick board turns on.

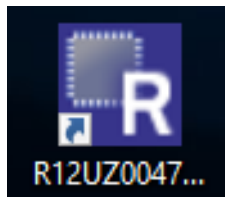


Figure 3. Desktop Icon

When the software starts, the DAQ Startup screen shown in [Figure 4 on page 4](#) appears. With the DAQ on a Stick connected, the USB Status indicator displays “Connected 0x2031”. The assigned HID code for this application is 0x2031, which verifies the software is communicating with the board.

If the DAQ on a Stick is not connected, or a problem exists with the demo, the message will read “HID Device Not Found”. If this occurs, click on the **Test USB Connection** button to enable the connection. If the connection is still not enabled, disconnect and reconnect the device, or restart the software.

## 2. Startup Screen

From the DAQ Startup Screen (Figure 4), click **Instantaneous Temperature** to get a single temperature reading or click **Start** to go to the Measurement Display screen shown in Figure 5. At this point, the green LED on the board turns off.

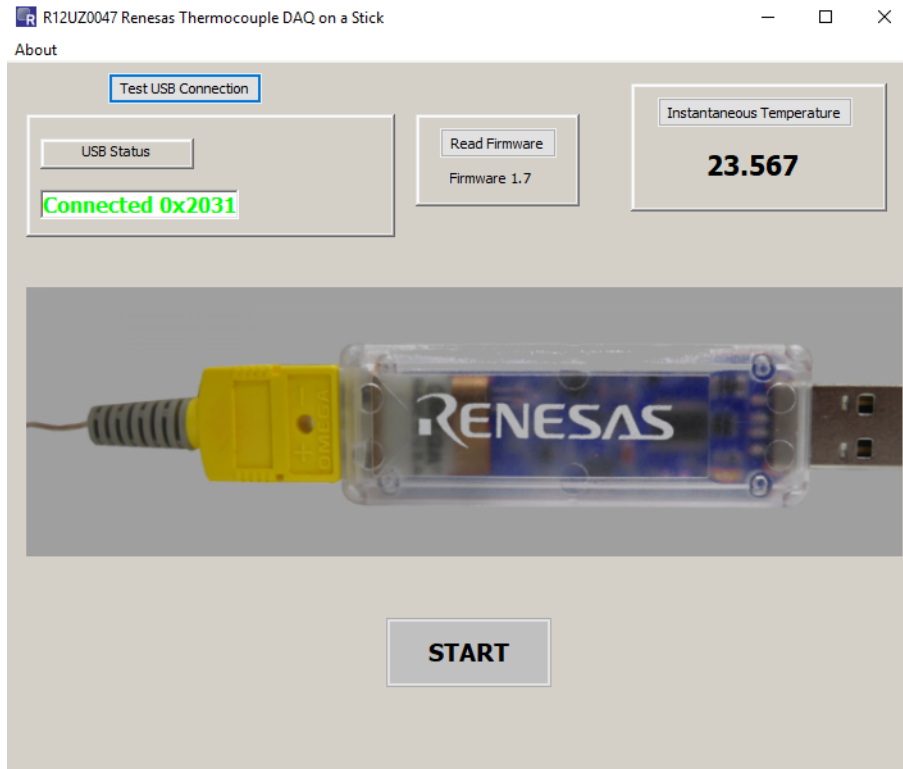


Figure 4. GUI Startup Screen

### 3. Measurement Display Screen

Click **Start** on the Startup Screen to go to the Measurement Display screen (Figure 5). From this screen you can do the following:

- Start and stop data collection
- Adjust the scaling of the X and Y axes (Automatic or Manual)
- Return to the startup screen by clicking on the **Show Main** button

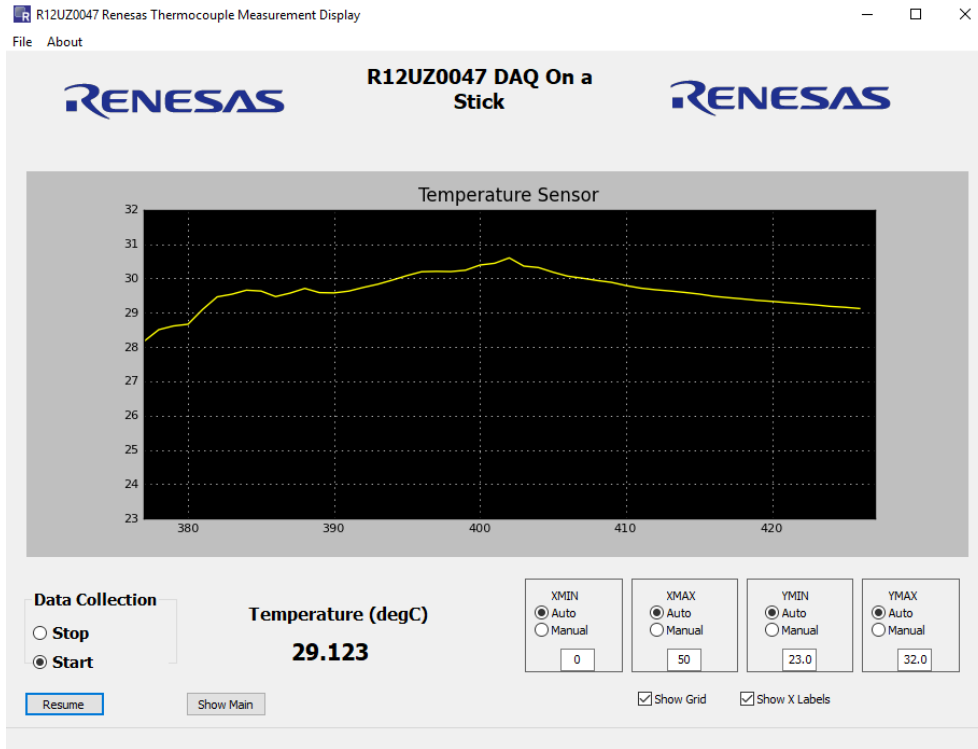


Figure 5. GUI Measurement Screen

#### 3.1 Data Collection Radio Box

The Data Collection radio box is one of the most actively used controls.

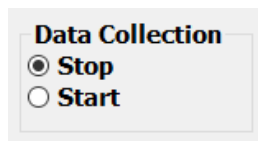


Figure 6. Data Collection Radio Box

- **Start** begins data collection and graphing in real time of the measured ADC values
- **Stop** halts data collection

#### 3.2 Graphing X and Y Axis Control

The X and Y axis control windows enable control of the graph area horizontal (XMIN, XMAX) and vertical (YMIN, YMAX) axes.

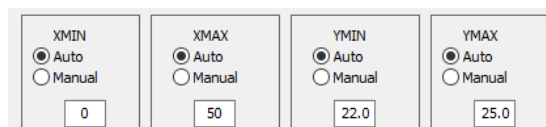
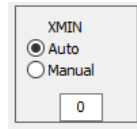


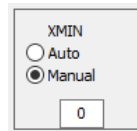
Figure 7. X and Y Axis Control

With **Auto** selected, the last 50 measurements are displayed as data collection runs, which produces a horizontal scrolling of the data.



**Figure 8. XMIN with Auto Selected**

To see the history of the sensor reading from the beginning, pin the X axis to 0 by clicking **Manual** in the XMIN box and enter 0 in the selection window.



**Figure 9. XMIN with Manual Selected**

Typing in another value in the selection window jumps to that location.

The Y axis is automatically adjusted as data is collected. However, when graphing “flat line” waveforms, you can select **Manual** while data collection is running and zoom the Y axis in to see further detail.

During initialization, the controls are set to **Auto**. When started, you can select **Manual** and change the Y axis.

**Note:** The axis controls affect the graph display area only. During data export, all data collected, regardless of graph scaling, is sent to the .csv file.

### 3.3 Grid and X Labels Check Boxes

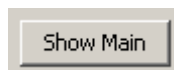
The **Show Grid** and **Show X Labels** boxes are graphing display options. Disable (deselect) **Show Grid** or **Show X Labels** to speed up real-time graphing display. These options can be enabled and disabled at any time.



**Figure 10. Grid and X Labels Check Boxes**

### 3.4 Show Main Button

The **Show Main** button re-displays the Startup screen.



**Figure 11. Show Main Button**

If clicked more than once, the Startup form can be hidden behind the Measurement Form. You can move the forms so both can be viewed simultaneously.

### 3.5 Measurement Display Menu Options

The Measurement Display has a Menu bar at the top.



**Figure 12. Measurement Display Menu Options**

- **File** exports collected data to a .csv file and captures a picture of the graph display
- **About** shows the firmware version

These items are discussed in more detail in the following sections.

### 3.5.1 File

In the **File** menu, click **Save Chart** to save an image of the Graph, or click **Export Data** to export the collected data to a .csv file to import it into other applications.

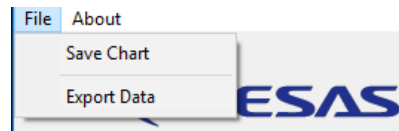


Figure 13. File Drop-Down Menu

### 3.5.2 About

The **About** menu provides information about the firmware version.



Figure 14. About Drop-Down Menu

## 4. Accuracy of Reference Design

The application circuit is calibrated at +25°C to within  $\pm 0.1^\circ\text{C}$  using a Fluke 54II Thermometer. The application accuracy of this design is within the achievable accuracy of the K-type thermocouple for temperatures above 0°C.

[Table 1](#) shows the limits of error for the K-type thermocouple.

**Table 1. Limits of Error for Thermocouple**

Thermocouple Type	Temperature Range (°C)	Limits Of Error
K	0 to +1250	$\pm 2.2^\circ\text{C}$ or $\pm 0.75\%$
K	-200 to 0	$\pm 2.2^\circ\text{C}$ or $\pm 2.0\%$

[Table 2](#) shows the measured accuracy across  $-40^\circ\text{C}$  to  $+125^\circ\text{C}$ .

**Table 2. Measured Accuracy of DAQ on a Stick**

Temperature Range (°C)	Measured Error (°C)
+25 to +125	0.7
0 to +125	0.7
-20 to +25	1.7
-40 to +25	3.5



## 5. Design Considerations

### 5.1 Temperature calculation

The temperature displayed on the GUI is calculated using the formula in Equation 1.  $V_{OUT}$  is the output voltage of the ISL28134 Chopper amplifier when set for a gain of 100.

$$(EQ. 1) \quad \text{Temperature} = \frac{(V_{OUT} - 1.1092)}{4.14\text{mV}/^{\circ}\text{C}}$$

### 5.2 ISL28134

The ISL28134 is an ideal choice for the input amplifier for a thermocouple design. The ISL28134 uses auto-correction circuitry to provide ultra low offset voltage (2.5 $\mu$ V), and low offset temperature drift (15nV/ $^{\circ}$ C). The very low 1/f noise corner <0.1Hz and low input noise voltage of the amplifier (8nV/ $\sqrt{\text{Hz}}$  at 100Hz) makes it ideal for low frequency precision applications requiring very high gain and low noise. Other key features of the ISL28134 are the wide gain bandwidth and rail-to-rail input/output swing.

### 5.3 ISL26102 24-bit ADC

The ISL26102 is a complete analog front-end with dual differential multiplexed inputs for high resolution measurements. The ISL26102 features a third order modulator providing up to 21.4-bit noise-free performance (10Sps). The 24-bit delta-sigma analog-to-digital converter includes a very low-noise amplifier with programmable gain. Although this application demo uses an input buffer amplifier (ISL28134), the high input impedance of the ISL26102 allows direct connection of sensors, such as load cell bridges to ensure the specified measurement accuracy without a buffer amplifier.

To initiate a correct power-up reset, diode  $D_1$ , resistor  $R_3$  and capacitor  $C_8$  implement a simple RC delay to ensure the  $\overline{\text{PDWN}}$  transitions from low-to-high after both power supplies have settled to specified levels.

### 5.4 ISL21010 (3.3V) Voltage Reference

The ISL21010CFH333 is a precision 3.3V, low dropout micropower band-gap voltage reference, which provides a  $\pm 0.2\%$  accurate reference. The ISL21010 provides up to 25mA output current sourcing with low 150mV dropout voltage. The low supply current and low dropout voltage combined with high accuracy make the ISL21010 ideal for precision low powered applications.

### 5.5 ISL21010 (4.096V) Voltage Reference

The ISL21010CFH341 is a precision 4.096V, low dropout micropower band-gap voltage reference, which provides a  $\pm 0.2\%$  accurate reference. The ISL21010 provides up to 25mA output current sourcing with low 150mV dropout voltage. The low supply current and low dropout voltage combined with high accuracy make the ISL21010 ideal for precision low powered applications.

### 5.6 ISL22317 DCP

The highly precise ISL22317 features a low end-to-end temperature coefficient of  $\pm 10\text{ppm}/^{\circ}\text{C}$  and precise resistance selection. It maintains less than  $\pm 1\%$  typical variance from the ideal resistance at each wiper position providing 99% accuracy of selected resistance value, which eliminates the need for complex algorithms to ensure precision. The ISL22317 operates from a single supply between 2.7V to 5.5V.

## 5.7 Bill of Materials

Part Number	Ref Des	Qty	Value	Tol.	Voltage (V)	Power	Package Type	Jedec Type	Mfr	Description
250R07C100JV4T	C1, C3	2	10pF	5%	25		402	CAP_0402RF	Johanson-Tech	C Series High-Q Chip Cap
GRM21BR71C475KA73L	C13	1	4.7μF	10%	16		805	CAP_0805	Murata	CERAMIC CAP
Generic	C9, C12, C15, C20	4	0.01μF	10%	16		402	CAP_0402	Various	Multilayer Cap
Generic	C5, C8, C10, C14, C16	5	0.1μF	10%	16		402	CAP_0402	Various	Multilayer Cap
Generic	C18, C19	2	OPEN	OPEN	OPEN		402	CAP_0402	Various	Multilayer Cap
Generic	C2, C7, C11, C22	4	1μF	20%	16		603	CAP_0603	Various	Ceramic Cap
Generic	C6	1	0.33μF	10%	25		603	CAP_0603	Various	Multilayer Cap
Generic	C17	1	2.2μF	10%	16		805	CAP_0805	Various	Multilayer Cap
Generic	C4	1	10μF	10%	16		1206	CAP_1206	Various	Multilayer Cap
597-3311-407	D1	1					SMD	DIA_LED1206	Dialight	Surface Mount Green LED
BAT54	D2	1					SINGLE	SOT23	Diodes	30V SCHOTTKY DIODE
MMSD4148T1	D3, D4	2					SOD123	SOD123	ON-Semi	Switching Diode
48037-1000	J1	1					MOLEX1	CON_USB_MOLEX_480371000	Molex	Right Angle USB A-Type Receptacle
PCC-SMP-K-100-R	J2	1					CON1	CON_PCC-SMP	Omega	Type K Thermocouple PCB Connector with Clip
251206102Y1	L1	1	1μH				SMD	SM1210	Fair-Rite	FERRITE BEAD
PAD_62	P1, P2	2	DNP				THOLE	PAD-62	Various	0.062 Pad with 0.041 Plated Thru Hole
Generic	R18	1	10k	0.10%		1/10W	805	RES_0805	Various	Metal Film Chip Resistor
Generic	R6, R9	2	0	0%		1/16W	402	RES_0402	Various	Thick Film Chip Resistor
Generic	R2, R3	2	100	1%		1/16W	402	RES_0402	Various	Thick Film Chip Resistor
Generic	R10, R12, R16, R19	4	1k	1%		1/16W	402	RES_0402	Various	Thick Film Chip Resistor
Generic	R1, R4, R11	3	10k	1%		1/16W	402	RES_0402	Various	Thick Film Chip Resistor
Generic	R15	1	100k	1%		1/16W	402	RES_0402	Various	Thick Film Chip Resistor
Generic	R13	1	102	1%		1/16W	402	RES_0402	Various	Thick Film Chip Resistor
Generic	R5	1	220	1%		1/16W	402	RES_0402	Various	Thick Film Chip Resistor

Part Number	Ref Des	Qty	Value	Tol.	Voltage (V)	Power	Package Type	Jedec Type	Mfr	Description
Generic	R14	1	24.9k	1%		1/16W	402	RES_0402	Various	Thick Film Chip Resistor
Generic	R7, R8, R20, R21	4	4.99k	1%		1/16W	402	RES_0402	Various	Thick Film Chip Resistor
MCR03EZPFX3001	R17	1	3k	1%		1/10W	603	RES_0603	Rohm	Metal Film Chip Resistor
ISL26102AVZ	U1	1					TSSOP	TSSOP24_173_256	Renesas	24 Pin 173 Mil TSSOP Package
ISL21010CFH341Z	U2	1					SOT	SOT23-3	Renesas	3 PIN SOT23-3 PACKAGE
IP4220CZ6	U3	1					SOT457	SOT457	NXP	Dual USB 2.0 Integrated ESD Protection
LM335Z	U4	1					TO92	TO92	National	PRECISION TEMPERATURE SENSOR
ISL28134FHZ	U5	1					SMD	SOT23-5	Renesas	5 Pin SOT23 Package
R5F10JBCANA	U6	1					QFN-S	QFN32_197X197_197_EPA	Renesas	32 LEAD QUAD FLAT PACKAGE (Pb-FREE)
ISL21010CFH333Z	U7	1					SOT	SOT23-3	Renesas	3 PIN SOT23-3 PACKAGE
ISL22317WFRTZ	U8	1					DFN3X3B	TDFN10_118X118_197_EPB	Renesas	10 Lead 3 X 3 0.5 Pitch Thin Dual Flat Package with E-Pad
NX5032GA-12.000M-LN-CD-1	Y1	1					SM	XTAL_NX5032GA	NDK	12.000MHz SM Crystal

### 5.8 RTKA-TCSTKEV1Z Evaluation Board Layout

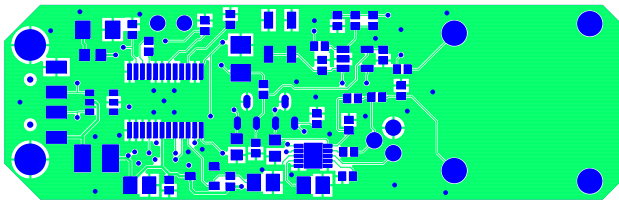


Figure 15. Top Layer

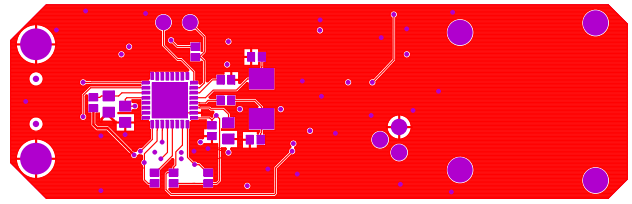


Figure 16. Bottom Layer

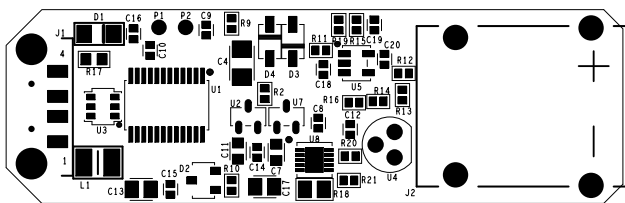


Figure 17. Top Assembly Drawing

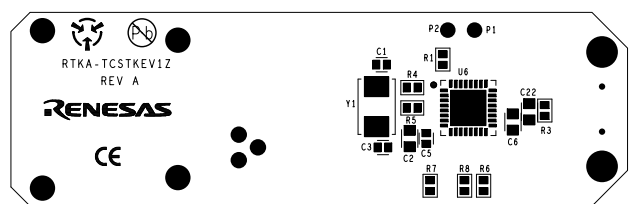


Figure 18. Bottom Assembly Drawing

### 5.9 RTKA-TCSTKEV1Z Schematic

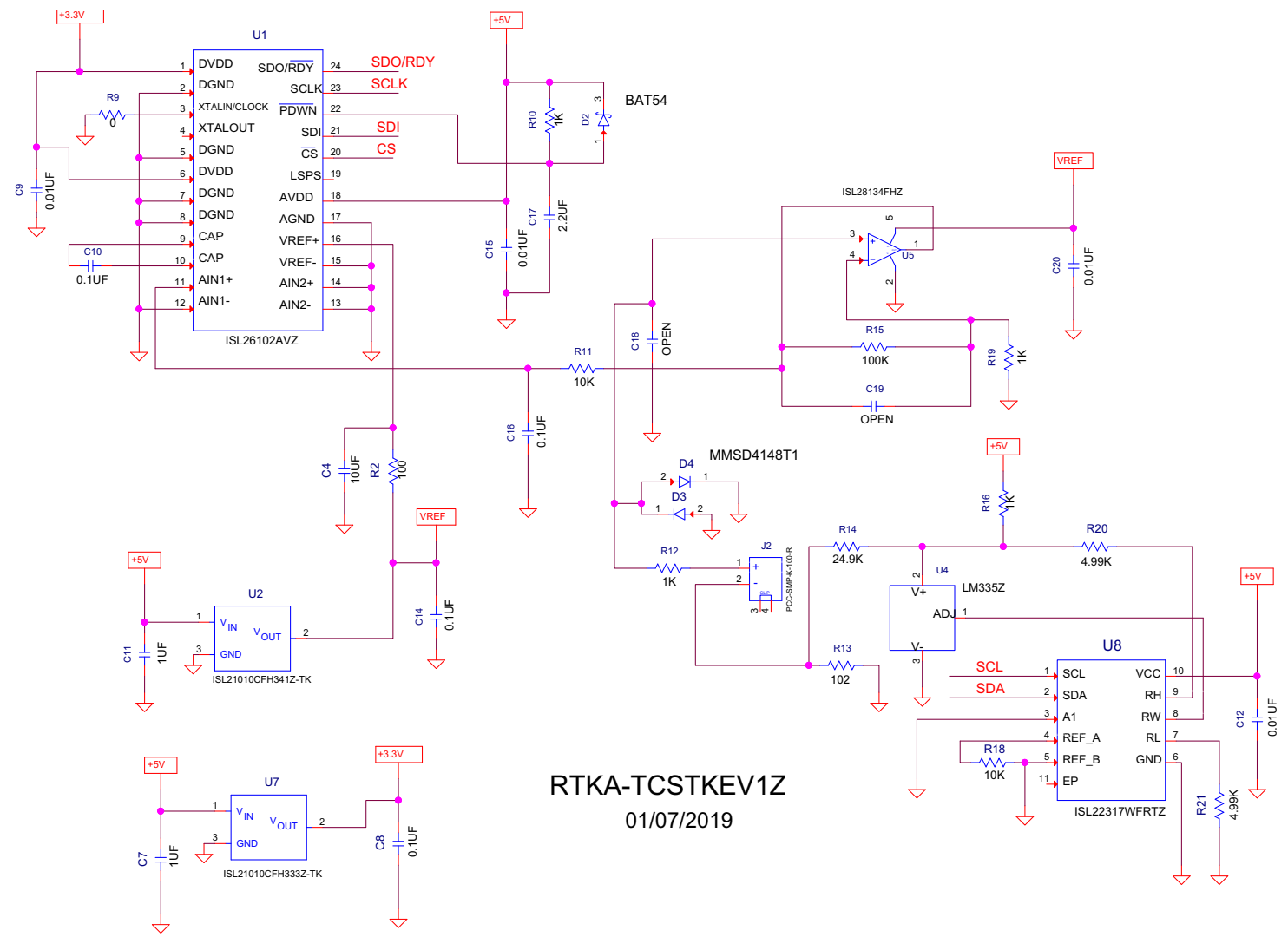


Figure 19. RTKA-TCSTKEV1Z Thermocouple Schematic



## 6. Revision History

Rev.	Date	Description
1.01	Jun.5.19	Updated ISL21010 information.
1.00	Apr.5.19	Initial release

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